



SYMBOLS	MIN.	NOM	MAX.
A	—	—	3.40
A1	0.25	—	—
A2	2.55	2.72	3.05
b	0.35	0.40	0.50
c	0.11	0.15	0.23
D	25.00 BASIC		
D1	20.00 BASIC		
e	1.00 BASIC		
E	19.00 BASIC		
E1	14.00 BASIC		
L	1.15	1.30	1.45
L1	2.50 REF		
θ°	0	3.5	7

UNIT : mm

NOTES:

- 1.JEDEC : N/A.
- 2.DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- 3.DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE. DIMENSIONS D1 AND E1 DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H .
- 4.DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION .

拟制		复审	
审核		会签	
制图		标准化	
幅面: A4		批准	
		比例: 1:1	

更改标记	更改内容	签 名	日 期
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VKXHQP64V11_POD 产品外形图名称		图 号:VKXHQP64V11_POD	
		单 位	版 本
		mm	V1.1
		第 1 张	共 1 张
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